



SPECIFICATION

- · Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- · Samsung P/N:
- CL05A106MQ5NUNC

(Reference sheet)

- · Description :
- CAP, 10uF, 6.3V, ±20%, X5R, 0402

A. Samsung Part Number

			<u>CL</u> ①	<u>05</u> ②	<u>А</u> Э	<u>106</u> ④	<u>M</u> 5	<mark>Q</mark> ©	<u>5</u> 7	<u>N</u> 8	<u>U</u> 9	<u>N</u> 10	<u>С</u> Ш	
1	Series	Samsung Multi-layer Ceramic Capacitor												
2	Size	0402 (ir	nch co	ode)		L:	1.00	± 0.20	mm			W:	0.50 ± 0.20 mm	n
3	Dielectric	X5R					8	Inner	elect	rode			Ni	
4	Capacitance	10 ul	F					Term	inatio	n			Cu	
5	Capacitance	±20 %)					Platir	g				Sn 100%	(Pb Free)
	tolerance						9	Produ	ıct				Size control c	ode
6	Rated Voltage	6.3 V					10	Speci	al				Reserved for	future use
1	Thickness	0.50 ± 0.20) mm				1	Packa	aging				Cardboard Ty	rpe, 7" reel

B. Structure & Dimension



Samsung P/N	Dimension(mm)								
Samsung F/N	L	W	Т	BW					
CL05A106MQ5NUNC	1.00 ± 0.20	0.50 ± 0.20	0.50 ± 0.20	0.25 ± 0.10					

C. Samsung Reliablility Test and Judgement Condition

Capacitance ∨ Tan δ (DF)	Within specified tolerance 0.125 max.	1 ^{kHz} ±10% / 0.5±0.1Vrms				
Tan δ (DF)	0.125 max.	*A capacitor prior to measuring the capacitance is heat				
		*A capacitor prior to measuring the capacitance is heat treated at $150^{\circ}C+0/-10^{\circ}C$ for 1 hour and maintained in ambient air for 24±2 hours.				
Insulation 1	10,000Mohm or 50Mohm× <i>µ</i> F	Rated Voltage 60~120 sec.				
Resistance	Whichever is smaller					
Appearance N	No abnormal exterior appearance	Microscope (×10)				
Withstanding	No dielectric breakdown or	250% of the rated voltage				
Voltage n	nechanical breakdown					
Temperature X	<5R					
Characteristics (From-55℃ to 85℃, Capacitance change sh	ould be within ±15%)				
Adhesive Strength	No peeling shall be occur on the	500g·f, for 10±1 sec.				
of Termination te	erminal electrode					
Bending Strength C	Capacitance change : within ±12.5%	Bending to the limit (1mm)				
		with 1.0mm/sec.				
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder				
is	s to be soldered newly	245±5℃, 3±0.3sec.				
		(preheating : 80~120℃ for 10~30sec.)				
Resistance to C	Capacitance change : within ±7.5%	Solder pot : 270±5℃, 10±1sec.				
	Γan δ, IR : initial spec.					
	Capacitance change : within ± 5% Γan δ, IR : initial spec.	Amplitude : 1.5mm From 10Hz to 55Hz (return : 1min.) 2hours × 3 direction (x, y, z)				
Moisture	Capacitance change : within ±12.5%	With rated voltage				
Resistance T	Γan δ : 0.25 max	40±2℃, 90~95%RH, 500+12/-0hrs				
	R: 500Mohm or 3.5Mohm × μ F					
	Whichever is smaller					
High Temperature	Capacitance change : within ±12.5%	With ^{100%} of the rated voltage				
	-	Max. operating temperature				
	R: 1,000Mohm or 7Mohm × μ F	1000+48/-0hrs				
	Whichever is smaller					
Temperature C	Capacitance change : within ±15%	1 cycle condition				
	Γan δ, IR : initial spec.	Min. operating temperature \rightarrow 25°C				
		\rightarrow Max. operating temperature \rightarrow 25°C				
		5 cycle test				

X The reliability test condition can be replaced by the corresponding accelerated test condition.

D. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5°C, 10sec. Max)

Product specifications included in the specifications are effective as of March 1, 2013. Please be advised that they are standard product specifications for reference only. We may change, modify or discontinue the product specifications without notice at any time. So, you need to approve the product specifications before placing an order.

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Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.